

| | Ink | Cubic | Optronics | I | echnology Co.,Lt | d | |
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| File Name | Specification For Ink Cubic 4.2" EPD | Module Number | M006F-J |
|-----------|--------------------------------------|---------------|---------|
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PRODUCT SPECIFICATION

| EPD | NO: | MF-14202-M006F-J |
|------------|-------|------------------|
| | | |
| CUST | OMER: | |

| APPROVED BY CUSTOMER | | |
|----------------------|--------|--|
| Approved by | Remark | |
| | | |
| | | |

| APPROVED BY Ink Cubic | | | | |
|-----------------------|--------------|----------|--------------|--|
| Prepared by | Checked by | | Approved by | |
| | EE | ME | | |
| Hao Tong | Chuanqing Wu | Hao Tong | Shengjun Zhu | |



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| Version | Content | Date | Producer |
|---------|-------------|----------|----------|
| A0 | New release | 2023/6/2 | Wu |
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1. General Description

Ink Cubic M006F-J is an Active Matrix Electrophoretic Display (AMEPD), with interface and a reference system design. The 4.2" active area contains 400×300 pixels, and has 1-bit B/W/R full display capabilities. An integrated circuit contains gate buffer, source buffer, interface, timing control logic, oscillator, DC-DC, SRAM, LUT, VCOM and border are supplied with each panel.

2. Features

- 400×300 pixels display
- High contrast
- High reflectance
- Ultra wide viewing angle
- Ultra low power consumption
- Pure reflective mode
- Bi-stable display
- Commercial temperature range
- Landscape, portrait modes
- Hard-coat antiglare display surface
- Ultra Low current deep sleep mode
- On chip display RAM
- Low voltage detect for supply voltage
- High voltage ready detect for driving voltage
- Internal temperature sensor
- 10-byte OTP space for module identification
- Waveform stored in On-chip OTP
- Serial peripheral interface available
- On-chip oscillator
- On-chip booster and regulator control for generating VCOM, Gate and Source driving voltage
- I2C signal master interface to read external temperature sensor/built-in temperature sensor

3.Application

Electronic Shelf Label System

4. Mechanical Specifications

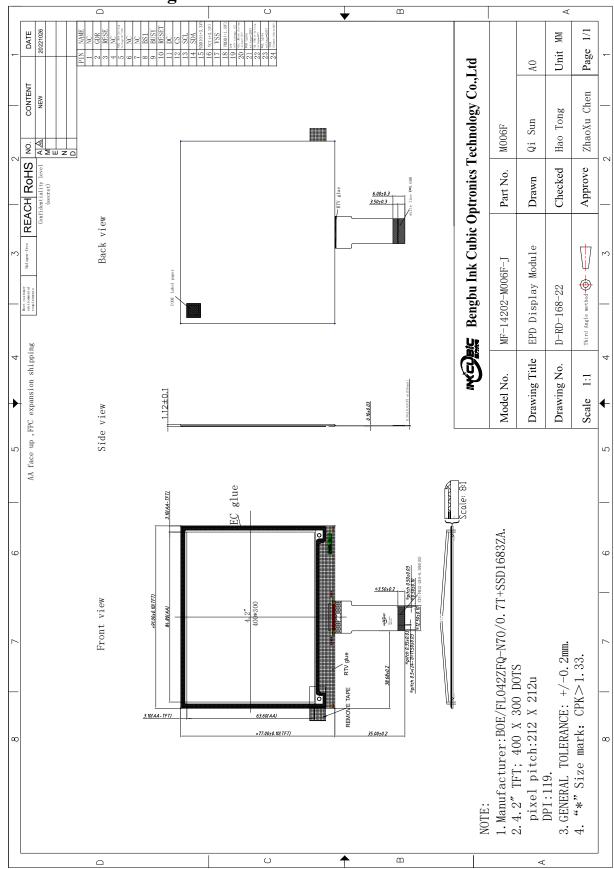
| Parameter | Specifications | Unit | Remark |
|---------------------|---------------------------|-------|---------|
| Screen Size | 4.2 | Inch | |
| Display Resolution | 400(H)×300(V) | Pixel | Dpi:119 |
| Active Area | 84.8(H)×63.6(V) | mm | * |
| Pixel Pitch | 0.212×0.212 | mm | |
| Pixel Configuration | Rectangle | | |
| | 9 | | |
| Outline Dimension | 91.0(H)×77.0 (V) ×1.12(D) | mm | |
| Weight | 15.5 \pm 0.5 | g | |



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5. Mechanical Drawing of EPD module





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6.Input/Output Terminals

| Pin# | Single | Description | Remark |
|------|--------|--|-----------|
| 1 | NC | No connection and do not connect with other NC pins | Keep Open |
| 2 | GDR | N-Channel MOSFET Gate Drive Control | |
| 3 | RESE | Current Sense Input for the Control Loop | |
| 4 | NC | No connection and do not connect with other NC pins | Keep Open |
| 5 | VSH2 | Positive Source driving voltage | |
| 6 | NC | No connection and do not connect with other NC pins | Keep Open |
| 7 | NC | No connection and do not connect with other NC pins | Keep Open |
| 8 | BS1 | Bus selection pin | Note 6-5 |
| 9 | BUSY | Busy state output pin | Note 6-4 |
| 10 | RES# | Reset signal input. | Note 6-3 |
| 11 | D/C # | Data /Command control pin | Note 6-2 |
| 12 | CS# | The chip select input connecting to the MCU. | Note 6-1 |
| 13 | SCL | Serial clock pin for interface. | |
| 14 | SDA | Serial data pin for interface. | |
| 15 | VDDIO | Power input pin for the Interface. | |
| 16 | VCI | Power Supply pin for the chip | |
| 17 | VSS | Ground (Digital) | |
| 18 | VDD | Core logic power pin | |
| 19 | VPP | Power Supply for OTP Programming | |
| 20 | VSH1 | Positive Source driving voltage | |
| 21 | VGH | Power Supply pin for Positive Gate driving voltage and VSH | |
| 22 | VSL | Negative Source driving voltage | |
| 23 | VGL | Power Supply pin for Negative Gate driving voltage, VCOM and VSL | |
| 24 | VCOM | VCOM driving voltage | |

Note 6-1: This pin (CS#) is the chip select input connecting to the MCU. The chip is enabled for MCU communication: only when CS# is pulled LOW.

Note 6-2: This pin (D/C#) is Data/Command control pin connecting to the MCU. When the pin ispulled HIGH, the data will be interpreted as data. When the pin is pulled LOW, the data will be interpreted as command.

Note 6-3: This pin (RES#) is reset signal input. The Reset is active low.

Note 6-4: This pin (BUSY) is Busy state output pin. When Busy is High ,the operation of chip shouldnot be interrupted and any commands should not be issued to the module. The driver IC will put Busypin High when the driver IC is working such as:

- Outputting display waveform; or



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⁻ Communicating with digital temperature sensor

Note 6-5: This pin (BS1) is for 3-line SPI or 4-line SPI selection. When it is "Low", 4-line SPI isselected. When it is "High", 3-line SPI (9 bits SPI) is selected

7.MCU Interface

7.1 MCU interface selection

The Ink Cubic M006F-J can support 3-wire/4-wire serial peripheral interface. In the Module, the MCU interface is pin selectable by BS1 pins shown in.

Table 7-1: MCU interface selection

| BS1 | MPU Interface | |
|-----|--|--|
| L | 4-lines serial peripheral interface (SPI) | |
| Н | 3-lines serial peripheral interface (SPI) - 9 bits SPI | |

7.2 MCU Serial Peripheral Interface (4-wire SPI)

The 4-wire SPI consists of serial clock SCL, serial data SDA, D/C# and CS#. The control pins status in 4-wire SPI in writing command/data is shown in Table 7-2 and the write procedure 4-wire SPI is shown in Figue 7-2.

Table 7-2: Control pins status of 4-wire SPI

| Function | SCL pin | SDA pin | D/C# pin | CS# pin |
|---------------|----------|-------------|----------|---------|
| Write command | ↑ | Command bit | L | L |
| Write data | ↑ | Data bit | Н | L |

Note:

- (1) L is connected to VSS and H is connected to VDDIO
- (2) ↑ stands for rising edge of signal

In the write mode, SDA is shifted into an 8-bit shift register on each rising edge of SCL in the order of D7, D6, ... D0. The level of D/C# should be kept over the whole byte. The data byte in the shift register is written to the Graphic Display Data RAM (RAM)/Data Byte register or command Byte register according to D/C# pin.

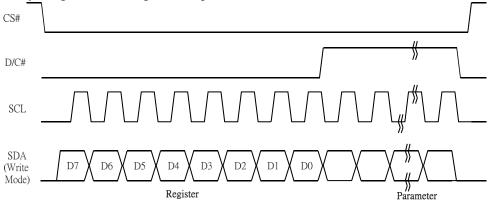


Figure 7-1: Write procedure in 4-wire SPI mode

In the Read mode:

1. After driving CS# to low, MCU need to define the register to be read.



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- 2. SDA is shifted into an 8-bit shift register on each rising edge of SCL in the order of D7, D6, ...D0 with D/C# keep low.
- 3. After SCL change to low for the last bit of register, D/C# need to drive to high.
- 4. SDA is shifted out an 8-bit data on each falling edge of SCL in the order of D7, D6, ... D0.
- 5. Depending on register type, more than 1 byte can be read out. After all byte are read, CS# needto drive to high to stop the read operation.

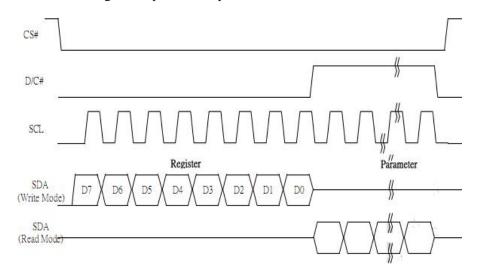


Figure 7-2: Read procedure in 4-wire SPI mode

In the write mode, SDA is shifted into an 8-bit shift register on each rising edge of SCL in the order of D7, D6, ... D0. The level of D/C# should be kept over the whole byte. The data byte in the shift register is written to the Graphic Display Data RAM (RAM)/Data Byte register or command Byte register according to D/C# pin.

7.3 MCU Serial Peripheral Interface (3-wire SPI)

The 3-wire SPI consists of serial clock SCL, serial data SDA and CS#. The operation is similar to 4-wire SPI while D/C# pin is not used and it must be tied to LOW. The control pins status in 3-wire SPI is shown in Table 7-3.

Table 7-3: Control pins status of 3-wire SPI

| Function | SCL pin | SDA pin | D/C# pin | CS# pin |
|---------------|----------|-------------|----------|---------|
| Write command | ↑ | Command bit | Tie LOW | L |
| Write data | ↑ | Data bit | Tie LOW | L |

Note:

- (1) L is connected to V_{SS} and H is connected to V_{DDIO}
- (2) ↑ stands for rising edge of signal

In the write operation, a 9-bit data will be shifted into the shift register on each clock rising edge. The bit shifting sequence is D/C# bit, D7 bit, D6 bit to D0 bit. The first bit is D/C# bit which determines the following byte is command or data. When D/C# bit is 0, the following byte is command. When D/C# bit is 1, the following byte is data. shows the write procedure in 3-wire SPI.



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| | C8# | | |
| scl | | | |
| | $\begin{array}{c c} SDA_{e^{i}} & 0 & D7 & D6 & D5 & D4 & D3 & D2 & D1 \\ (Write \\ Mode)_{e^{i}} & 0 & D7 & D6 & D5 & D4 & D3 & D2 & D1 \\ \end{array}$ | D0 1 D7+ | |
| | Register | Parameter | |

Figure 7-3: Write procedure in 3-wire SPI mode

In the Read mode:

- 1. After driving CS# to low, MCU need to define the register to be read.
- 2. D/C#=0 is shifted thru SDA with one rising edge of SCL
- 3. SDA is shifted into an 8-bit shift register on each rising edge of SCL in the order of D7, D6, ...D0.
- 4. D/C#=1 is shifted thru SDA with one rising edge of SCL
- 5. SDA is shifted out an 8-bit data on each falling edge of SCL in the order of D7, D6, · · · D0.
- 6. Depending on register type, more than 1 byte can be read out. After all byte are read, CS# needto drive to high to stop the read operation.

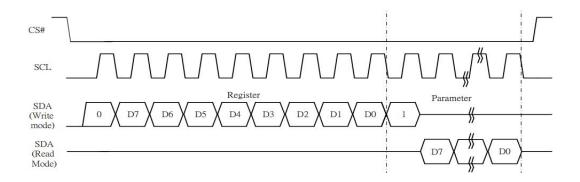


Figure 7-4: Read procedure in 3-wire SPI mode



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8. Reference Circuit

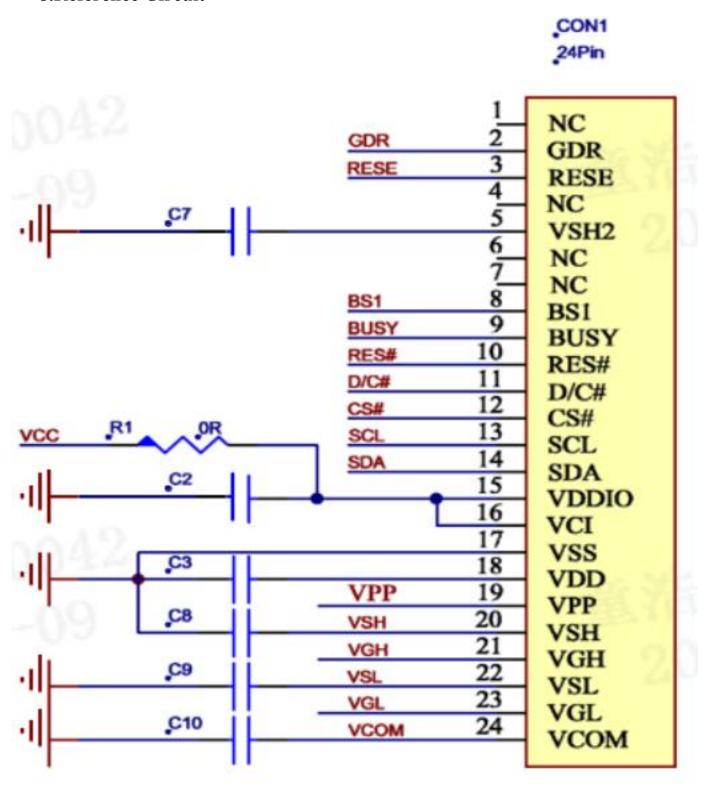


Figure. 8-1



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| | _p1 | | |

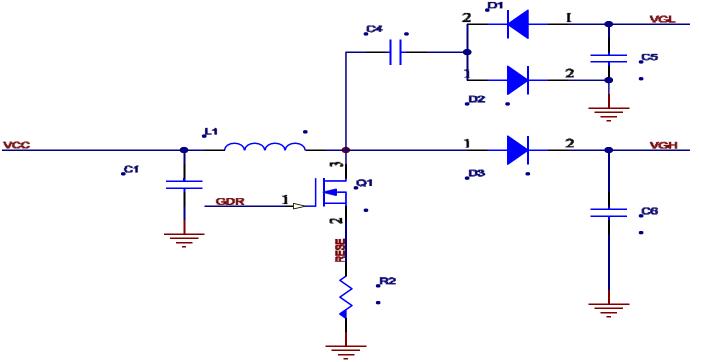


Figure. 8-2

| Part Name | SSD1683 Value /quirement/Reference Part |
|-----------|---|
| C1—C9 | 1uF/0603;X5R/X7R;Voltage Rating: 25V |
| C10 | 1uF/0603;X7R;Voltage Rating: 25V |
| D1—D3 | MBR0530 |
| | 1) Reverse DC voltage≥30V |
| | 2) Forward current≥500mA |
| | 3)Forward voltage≤430mV |
| R2 | 2.2 Ω/0603: 1% variation |
| Q1 | NMOS:Si1304BDL/NX3008NBK |
| | 1) Drain-Source breakdown voltage ≥30V |
| | 2) $Vgs (th) = 0.9 (Typ) , 1.3V (Max)$ |
| | 3) Rds on $\leq 2.1 \Omega$ @ Vgs=2.5V |
| L1 | 47uH/CDRH2D18、LDNP-470NC |
| | Maximum DC current~420mA |
| | Maximum DC resistance~650m Ω |



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9. Absolute Maximum Rating

Table 9-1: Maximum Ratings

| Crymbal | Danamatan | Dating | IIn:4 | Humidity | IIni4 | Note |
|-----------|----------------------------------|--------------|-------|----------|-------|-------------------------------|
| Symbol | Parameter | Rating | Unit | Humidity | Unit | Note |
| V_{CI} | Logic supply voltage | -0.5 to +6.0 | V | - | - | |
| T_{OPR} | Operation temperature range | 0 to 40 | °C | 35 to 70 | % | Note 9-1 |
| Tttg | Transportation temperature range | -25 to 60 | °C | 35 to 70 | % | Note 9-2 |
| Tstg | Storage condition | 0 to 40 | °C | 35 to 70 | % | Maximum storage time: 5 years |
| - | After opening the package | 0 to 40 | °C | 35 to 70 | % | |

- Note 9-1: We guarantee the single pixel display quality for $0-35^{\circ}$ C, but we only guarantee the barcode readable for $35-40^{\circ}$ C. Normal use is recommended to refresh every 24 hours.
- Note 9-2: Tttg is the transportation condition, the transport time is within 10 days for $-25^{\circ}\text{C} \sim 0^{\circ}\text{C}$ or $40^{\circ}\text{C} \sim 60^{\circ}\text{C}$.
- Note 9-3: When the three-color product is stored. The display screen should be kept white and face up. In addition, please be sure to refresh the e-paper every three months.

10.DC Characteristics

The following specifications apply for: VSS=0V, VCI=3.3V, T_{OPR}=25°C.

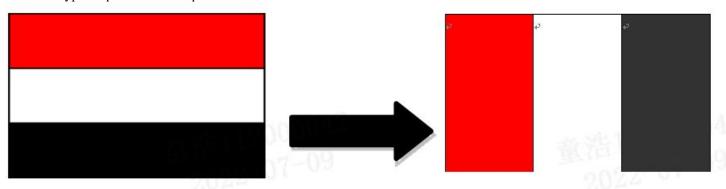
Table 13-1: DC Characteristics

| Symbol | Parameter | Test Condition | Applicable pin | Min. | Тур. | Max. | Unit |
|---------|---------------------------|-----------------------|----------------------------|----------|------|---------|------|
| VCI | VCI operation voltage | - | VCI | 2.3 | 3 | 3.7 | V |
| VIH | High level input voltage | - | SDA, SCL, CS#, D/C#, RES#, | 0.8VDDIO | | | V |
| VIL | Low level input voltage | - | BS1 | - | - | 0.2VDDI | V |
| | | | | | | O | |
| VOH | High level output voltage | IOH = -100uA | BUSY | 0.9VDDIO | - | - | V |
| VOL | Low level output voltage | IOL = 100uA | | - | - | 0.1VDDI | V |
| | | | | | | O | |
| Iupdate | Module operating current | - | - | - | 6 | - | mA |
| Isleep | Deep sleep mode | VCI=3.3V | - | - | - | 3 | uA |

The Typical power consumption is measured using associated 25°C waveform with following pattern transition: from horizontal scan pattern to vertical scan pattern. (Note10-1)

- The listed electrical/optical characteristics are only guaranteed under the controller &waveform provided by Ink Cubic
- Vcom value will be OTP before in factory or present on the label sticker. (Note10-1)

The Typical power consumption





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11. Serial Peripheral Interface Timing and Command Table

11.1 Serial Peripheral Interface Timing

The following specifications apply for: VSS=0V, VCI=2.3V to 3.7V, T_{OPR}=25°C

Write mode

| Symbol | Parameter | Min | Тур | Max | Unit |
|----------|--|-----|-----|-----|------|
| fSCL | SCL frequency (Write Mode) | | | 20 | MHz |
| tCSSU | Time CS# has to be low before the first rising edge of SCLK | 20 | | | ns |
| tCSHLD | Time CS# has to remain low after the last falling edge of SCLK | 20 | | | ns |
| tCSHIGH | Time CS# has to remain high between two transfers | 100 | | | ns |
| tSCLHIGH | Part of the clock period where SCL has to remain high | 25 | | | ns |
| tSCLLOW | Part of the clock period where SCL has to remain low | 25 | | | ns |
| tSISU | Time SI (SDA Write Mode) has to be stable before the next rising edge of SCL | 10 | | | ns |
| tSIHLD | Time SI (SDA Write Mode) has to remain stable after the rising edge of SCL | 40 | | | ns |

Read mode

| Symbol | Parameter | Min | Тур | Max | Unit |
|----------|--|-----|-----|-----|------|
| fSCL | SCL frequency (Read Mode) | | | 2.5 | MHz |
| tCSSU | Time CS# has to be low before the first rising edge of SCLK | 100 | | | ns |
| tCSHLD | Time CS# has to remain low after the last falling edge of SCLK | 50 | | | ns |
| tCSHIGH | Time CS# has to remain high between two transfers | 250 | | | ns |
| tSCLHIGH | Part of the clock period where SCL has to remain high | 180 | | | ns |
| tSCLLOW | Part of the clock period where SCL has to remain low | 180 | | | ns |
| tSOSU | Time SO(SDA Read Mode) will be stable before the next rising edge of SCL | | 50 | | ns |
| tSOHLD | Time SO (SDA Read Mode) will remain stable after the falling edge of SCL | | 0 | | ns |

Note: All timings are based on 20% to 80% of VDDIO-VSS

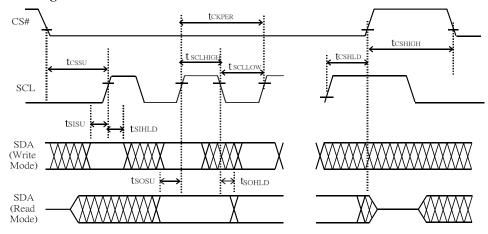


Figure 11-1: SPI timing diagram

11.2 Command Table

Please refer to IC Spec.



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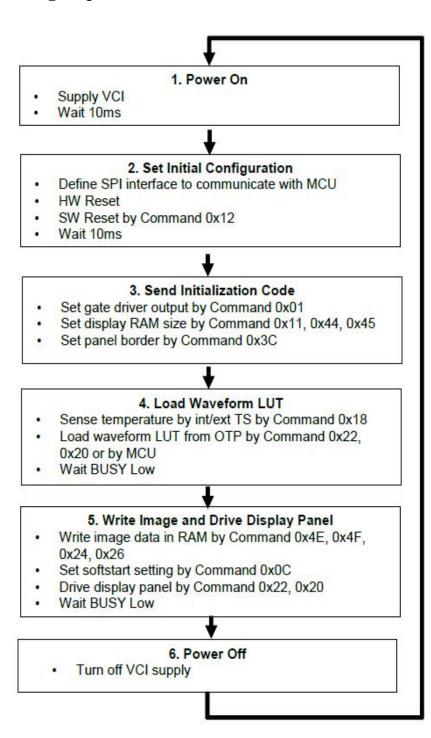
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12. Power Consumption

| Parameter | Symbol | Conditions | TYP | Max | Unit | Remark |
|---------------------------------------|--------|------------|-----|-----|------|--------|
| Panel power consumption during update | - | 25℃ | - | 180 | mAs | - |
| Deep sleep mode | - | 25℃ | - | 3 | uA | - |

mAs=update average current × update time

13. Typical Operating Sequence





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14. Optical characteristics

14.1 Specifications

Measurements are made with that the illumination is under an angle of 45 degrees, the detection is perpendicular unlessotherwise specified.

T=25°C

| | 1 23 0 | | | | | | |
|--------------|----------------------|----------------------------|-----|----------------------------|-----|----------|-----------|
| SYMBOL | PARAMETER | CONDITIONS | MIN | TYP. | MAX | UNI T | Note |
| R | Reflectance | White | 30 | 35 | - | % | Note 14-1 |
| CR | Contrast Ratio | - | 15 | 20 | - | | - |
| Gn | 2Grey Level | - | - | KS+(WS-KS)×n(m-1) | - | L* | - |
| KS | Black State L* value | | - | 10 | 14 | | Note 14-1 |
| K2 | Black State a* value | | - | - | 5 | | Note 14-1 |
| WS | White State L* value | | 62 | 64 | 1 | | Note 14-1 |
| RS | Red State L* value | Red | 24 | 26 | - | | Note 14-1 |
| KS | Red State a* value | Red | 37 | 40 | - | | Note 14-1 |
| Panel's life | - | 0℃~40℃ | | 5years | - | - | Note 14-2 |
| Panel | Image Update | Storage and transportation | - | Update the white screen | - | - | - |
| ranei | Update Time | Operation | - | Suggest Updated once a day | - | - | - |

WS: White state, KS: Black state, RS: Red state

Note 14-1: Luminance meter: i - One Pro Spectrophotometer

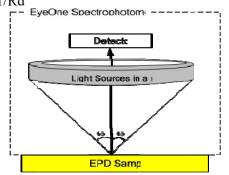
Note 14-2: We don't guarantee 5 years pixels display quality for humidity below 45%RH or above 70%RH; Suggest Updated once a day;

Note 14-3: To increases the black and white screen clear screen when red has refreshed for a long time, the effect is better. Note: It's only with the 25° C and 51° RH for 5 years.

14.2 Definition of contrast ratio

The contrast ratio (CR) is the ratio between the reflectance in a full white area (R1) and the reflectance in a dark area (Rd)():

R1: white reflectance Rd: dark reflectance CR = R1/Rd





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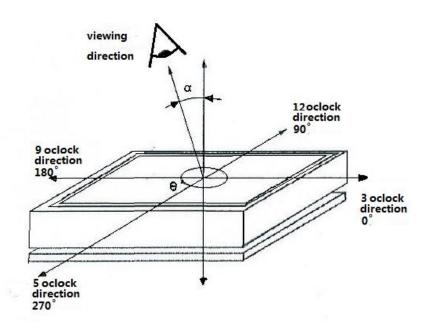
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14.3 Reflection Ratio

The reflection ratio is expressed as:

 $R = Reflectance \ Factor_{white \ board} \qquad x \left(L_{center} / L_{white \ board}\right)$

L $_{center}$ is the luminance measured at center in a white area (R=G=B=1). L $_{white\ board}$ is the luminance of a standard whiteboard. Both are measured with equivalent illumination source. The viewing angle shall be no more than 2 degrees.



15. Handling, Safety and Environental Requirements

WARNING

The display module should be kept flat or fixed to a rigid, curved support with limited bending along the long axis. It should not be used for continual flexing and bending. Handle with care. Should the display break do not touch any material that leaks out. In case of contact with the leaked material then wash with water and soap.

CAUTION

The display module should not be exposed to harmful gases, such as acid and alkali gases, which corrode electronic components.

Disassembling the display module can cause permanent damage and invalidate the warranty agreements.

IPA solvent can only be applied on active area and the back of a glass. For the rest part, it is not allowed.

Observe general precautions that are common to handling delicate electronic components. The glass can break and front surfaces can easily be damaged. Moreover the display is sensitive to static electricity and other rough environmental conditions.



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Mounting Precautions

- (1) It's recommended that you consider the mounting structure so that uneven force (ex. Twisted stress) is not applied to the module.
- (2) It's recommended that you attach a transparent protective plate to the surface in order to protect the EPD. Transparent protective plate should have sufficient strength in order to resist external force.
- (3) You should adopt radiation structure to satisfy the temperature specification.
- (4) Acetic acid type and chlorine type materials for the cover case are not desirable because the former generates corrosive gas of attacking the PS at high temperature and the latter causes circuit break by electro-chemical reaction.
- (5) Do not touch, push or rub the exposed PS with glass, tweezers or anything harder than HB pencil lead. And please do not rub with dust clothes with chemical treatment. Do not touch the surface of PS for bare hand or greasy cloth. (Some cosmetics deteriorate the PS)
- (6) When the surface becomes dusty, please wipe gently with absorbent cotton or other soft materials like chamois soaks with petroleum benzene. Normal-hexane is recommended for cleaning the adhesives used to attach the PS. Do not use acetone, toluene and alcohol because they cause chemical damage to the PS.
- (7) Wipe off saliva or water drops as soon as possible. Their long time contact with PS causes deformations and color fading.

| Data sheet status | | |
|-----------------------|---|--|
| Product specification | The data sheet contains final product specifications. | |

Limiting values

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and dose not form part of the specification.

| Product Environmental certification | | | | |
|-------------------------------------|--|--|--|--|
| ROHS | | | | |
| REMARK | | | | |
| | | | | |

All The specifications listed in this document are guaranteed for module only. Post-assembled operation or component(s) may impact module performance or cause unexpected effect or damage and therefore listed specifications is not warranted after any Post-assembled operation.



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16.Reliability test

| | TEST | CONDITION | REMARK |
|----|---|---|---------------------------|
| 1 | High-Temperature Operation | T=40°C, RH=35%RH, For 240Hr | |
| 2 | Low-Temperature Operation | T = 0°C for 240 Hr | |
| 3 | High-Temperature Storage | T=60℃ RH=35%RH For 240Hr | Test in white pattern |
| 4 | Low-Temperature Storage | T = -25°C for 240 Hr | Test in white pattern |
| 5 | High Temperature, High- Humidity Operation | T=40°C,RH=80%RH, For 240Hr | |
| 6 | High Temperature, High- Humidity Storage | T=50°C,RH=80%RH,For 240Hr | Test in white pattern |
| 7 | Temperature Cycle | -25°C(30min)~60°C(30min),50 Cycle | Test in white pattern |
| 8 | Package Vibration | 1.04G,Frequency: 20~200Hz Direction: X,Y,Z Duration: 30 minutes in each direction | Full packed for shipment |
| 9 | Package Drop Impact | Drop from height of 100 cm on Concrete surface Drop sequence:1 corner, 3edges, 6face One drop for each. | Full packed for shipment |
| 10 | Electrostatic discharge | HBM:330 Ω ,150pF | Air +/-4KV;Contact +/-2KV |
| 11 | UV Exposure Resistance | 765 W/ m² for 168hrs,40 ℃ | |

Actual EMC level to be measured on customer application.

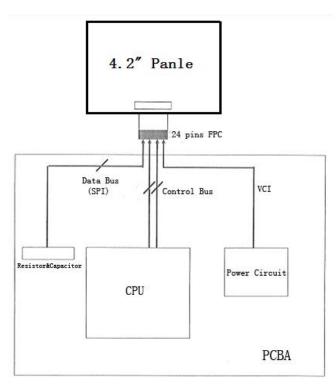
Note1: Stay white pattern for storage and non-operation test.

Note2: Operation is black/white/red pattern, hold time is 150S.

Note3: The function, appearance, opticals should meet the requirements of the test before and after the test.

Note4: Keep testing after 2 hours placing at 20°C-25°C

17.Block Diagram

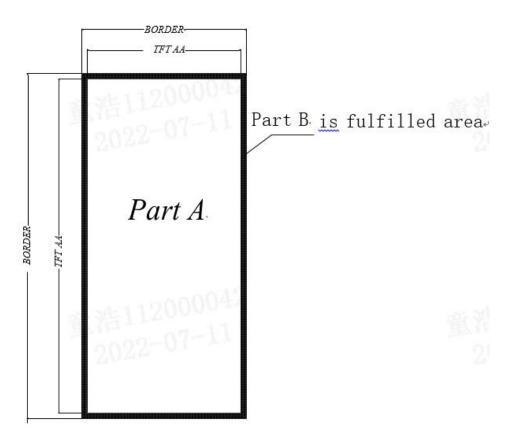




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18.PartA/PartB Specification



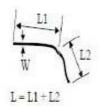
19. Point and line standard

| Shipment Inspection Standard | | | | | | |
|---|-------------------------------------|--------------------|-------------|-------------|--------|-------------|
| Equipment: Electrical test fixture, Point gauge | | | | | | |
| Outline dimension | $91(H) \times 77(V) \times 1.12(D)$ | Unit: mm | Part-A | Active area | Part-B | Border area |
| | Temperature | Humidity | Illuminance | Distance | Time | Angle |
| Environment | 19℃~25℃ | 55%±5% RH | 600~1200Lux | 300 mm | 35Sec | |
| Defect type | Inspection method | Standard D≤0.25 mm | | Part-A | Λ | Part-B |
| | | | | Ignor | e | Ignore |
| Spot | Electric Display | 0.25 mm < | D≤0.40 mm | N≤4 | 1 | Ignore |
| | | | | N≤2 | 2 | Ignore |
| | | | | Not A | Allow | Ignore |
| Display unwork | Electric Display | | | Not All | ow | Ignore |
| Display error | Electric Display | | | Not All | ow | Ignore |
| | | | | Ignor | e | Ignore |
| Scratch or line | | | | N≤2 | 2 | Ignore |



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| defect(include dirt) | Visual/Film card | L>3 mm,W>0.3 mm | | Not Allow | Ignore |
| | | D≤0.30mm | | Ignore | Ignore |
| PS Bubble | Visual/Film card | 0.30mm≤D≤0.50n | mm | N≤4 | Ignore |
| | | D>0.50mm | | Not Allow | Ignore Ignore Ignore Ignore Ignore it (Edge chipping) |
| Side Fragment | Visual/Film card | $X \leqslant 3$ mm, $Y \leqslant 0.5$ mm, Do not affect the $N \leqslant 2$; $X \leqslant 2$ mm, $Y \leqslant 2$ mm, Do not affect the $N \leqslant 2$; | | | |
| Remark | 1.Can | 1.Cannot be defect & failure cause by appearance defect; | | | |
| Kemark | 2.Cannot be larger size cause by appearance defect; | | | | |
| L=long W=wide D=point size N=Defects NO | | | | | |



D+(L+W)(2

L=long W=wide

D=point size

Line Defect

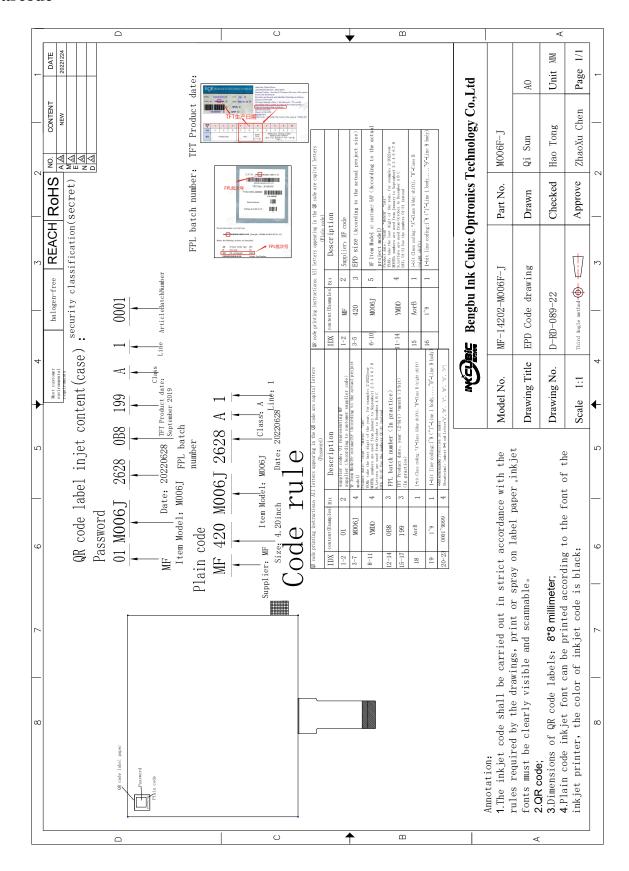
Spot Defect



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20.Barcode





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21.Packing

